

BFP650F

Low profile linear silicon NPN RF bipolar transistor



Product description

The BFP650F is a RF bipolar transistor based on SiGe:C technology that is part of Infineon's established sixth generation transistor family. Its transition frequency f_T of 42 GHz along with its linearity characteristics make the device suitable for oscillators. It remains cost competitive without compromising on ease of use.



Feature list

- Minimum noise figure $NF_{min} = 0.8$ dB at 1.8 GHz, 3 V, 10 mA
- High gain $G_{ma} = 21.5$ dB at 1.8 GHz, 3 V, 80 mA
- $OIP_3 = 31$ dBm at 1.8 GHz, 3 V, 80 mA

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC JESD47, JESD22, and J-STD-020. Qualified for industrial applications according to the relevant tests of AEC-Q 101.

Potential applications

- Low noise, high linearity amplifiers in SDARS receivers
- Low noise, high linearity amplifiers for ISM band applications
- Low noise, high linearity amplifiers for multimedia applications such as CATV

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration				Marking	Pieces / Reel
BFP650F / BFP650FH6327XTSA1	TSFP-4-1	1 = B	2 = E	3 = C	4 = E	R5s	3000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

Table of contents

	Product description	1
	Feature list	1
	Product validation	1
	Potential applications	1
	Device information	1
	Table of contents	2
1	Absolute maximum ratings	3
2	Thermal characteristics	4
3	Electrical characteristics	5
3.1	DC characteristics	5
3.2	General AC characteristics	5
3.3	Frequency dependent AC characteristics	6
3.4	Characteristic AC diagrams	7
4	Package information TSFP-4-1	10
	Revision history	11
	Disclaimer	12

Absolute maximum ratings

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25\text{ °C}$ (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	–	4.0	V	Open base
			3.7		$T_A = -55\text{ °C}$, open base
Collector emitter voltage	V_{CES}		13		E-B short circuited
Collector base voltage	V_{CBO}		13		Open emitter
Emitter base voltage	V_{EBO}		1.2		Open collector
Base current	I_B		10	mA	–
Collector current	I_C		150		
Total power dissipation ¹⁾	P_{tot}		500	mW	$T_S \leq 85\text{ °C}$
Junction temperature	T_J	–55	150	°C	–
Storage temperature	T_{Stg}				

Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

¹ T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Junction - soldering point	R_{thJS}	–	130	–	K/W	–

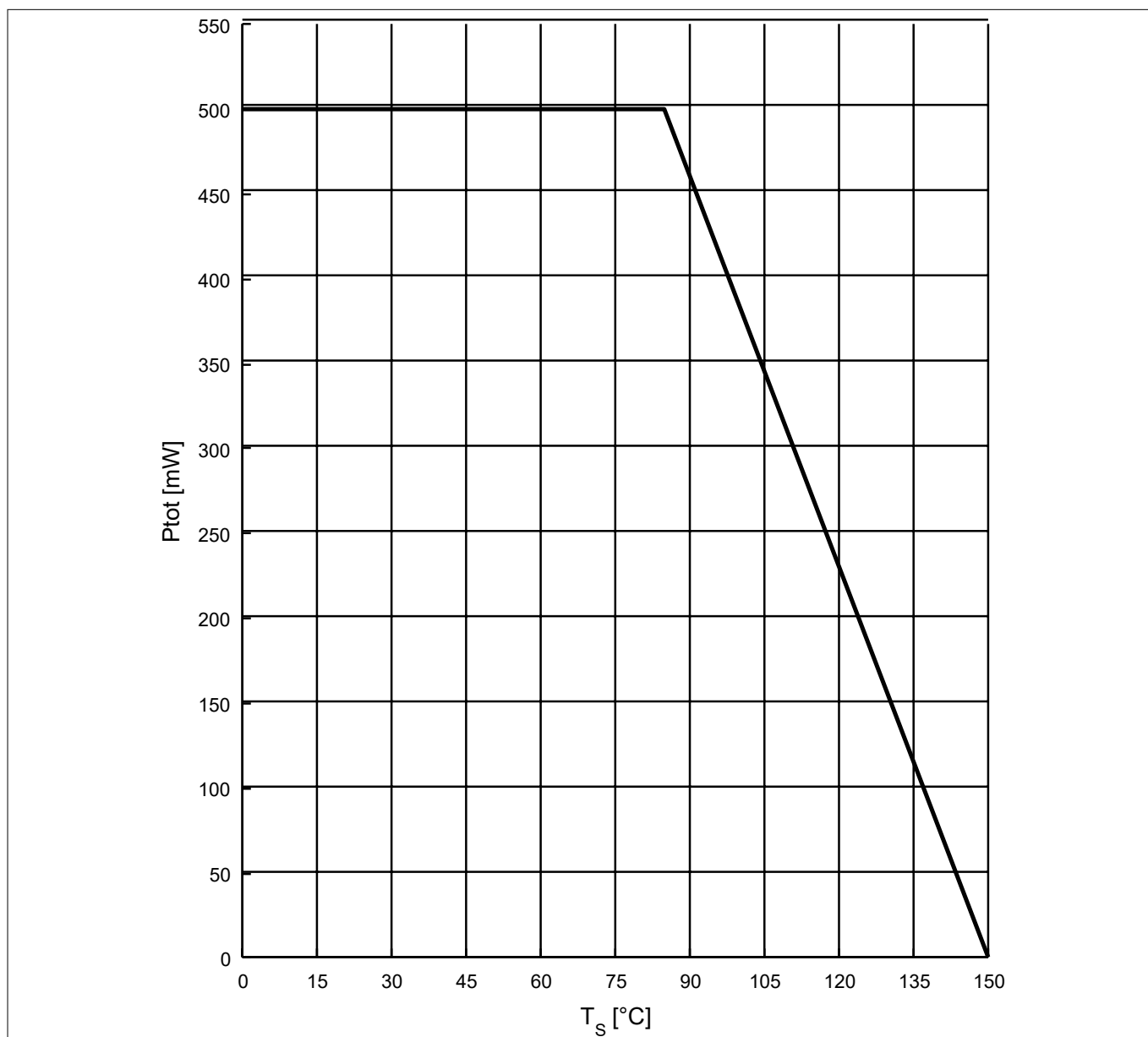


Figure 1 Total power dissipation $P_{tot} = f(T_S)$

Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(BR)CEO}$	4	4.5	–	V	$I_C = 3\text{ mA}$, $I_B = 0$, open base
Collector emitter leakage current	I_{CES}	–	–	100 ²⁾	μA	$V_{CE} = 13\text{ V}$, $V_{BE} = 0$, E-B short circuited
Collector base leakage current	I_{CBO}			100 ²⁾	nA	$V_{CB} = 5\text{ V}$, $I_E = 0$, open emitter
Emitter base leakage current	I_{EBO}			10 ²⁾	μA	$V_{EB} = 0.5\text{ V}$, $I_C = 0$, open collector
DC current gain	h_{FE}	110	180	270		$V_{CE} = 3\text{ V}$, $I_C = 80\text{ mA}$, pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Transition frequency	f_T	–	42	–	GHz	$V_{CE} = 3\text{ V}$, $I_C = 80\text{ mA}$, $f = 1\text{ GHz}$
Collector base capacitance	C_{CB}		0.26		pF	$V_{CB} = 3\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, emitter grounded
Collector emitter capacitance	C_{CE}		0.45			$V_{CE} = 3\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, base grounded
Emitter base capacitance	C_{EB}		1.3			$V_{EB} = 0.5\text{ V}$, $V_{CB} = 0$, $f = 1\text{ MHz}$, collector grounded

²⁾ Maximum values not limited by the device but by the short cycle time of the 100% test.

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, $T_A = 25^\circ\text{C}$.

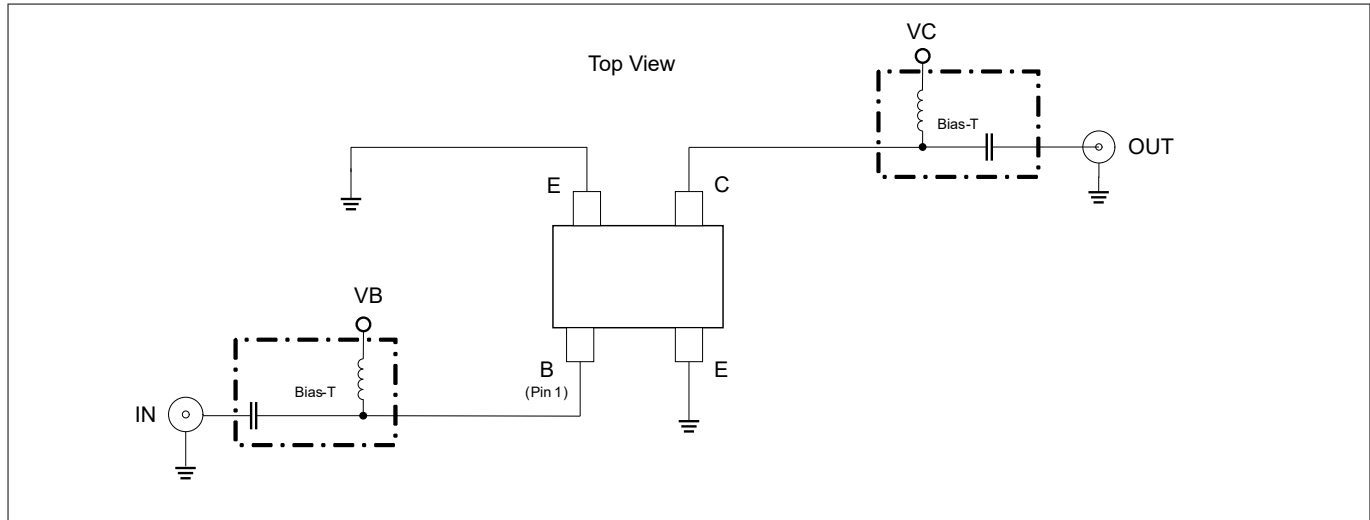


Figure 2 Testing circuit

Table 6 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 1.8\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain					dB	
• Maximum power gain	G_{ms}	–	21.5	–		$I_C = 80\text{ mA}$
• Transducer gain	$ S_{21} ^2$	15	17.5			
Noise figure					dBm	
• Minimum noise figure	NF_{min}	–	0.8			$I_C = 10\text{ mA}$
Linearity						
• 3rd order intercept point at output	OIP_3		31			$I_C = 80\text{ mA}$, $Z_S = Z_L = 50\ \Omega$
• 1 dB gain compression point at output	OP_{1dB}		17.5			

Table 7 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 6\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain					dB	
• Maximum power gain	G_{ms}	–	11	–		$I_C = 80\text{ mA}$
• Transducer gain	$ S_{21} ^2$		7.5			
Noise figure						
• Minimum noise figure	NF_{min}		1.9			$I_C = 10\text{ mA}$

Note: $G_{ms} = |S_{21}|^2 / S_{11}^2$ for $k < 1$; $G_{ma} = |S_{21}|^2 / S_{11}^2 (k^2 - 1)^{1/2}$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.2 MHz to 12 GHz.

3.4 Characteristic AC diagrams

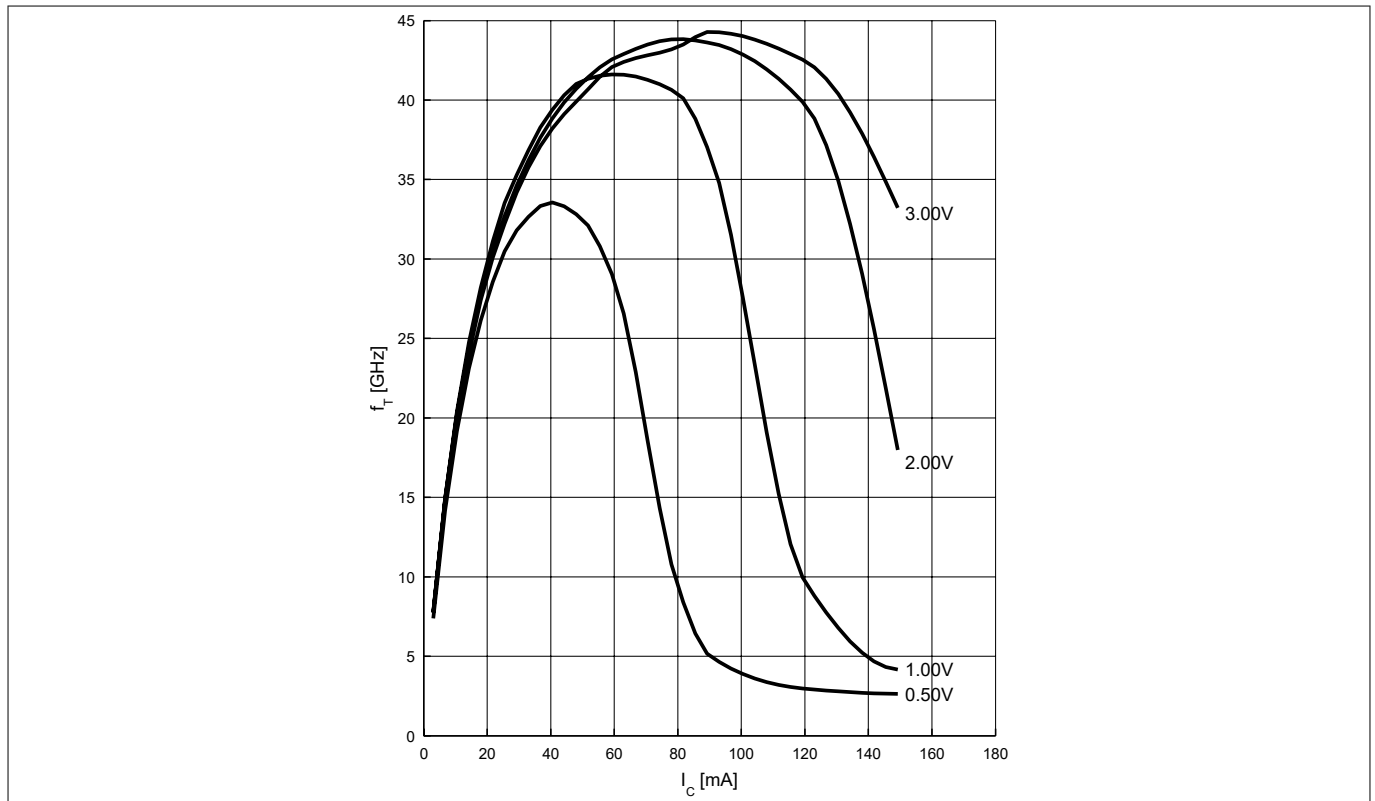


Figure 3 Transition frequency $f_T = f(I_C)$, $f = 1$ GHz, $V_{CE} = \text{parameter}$

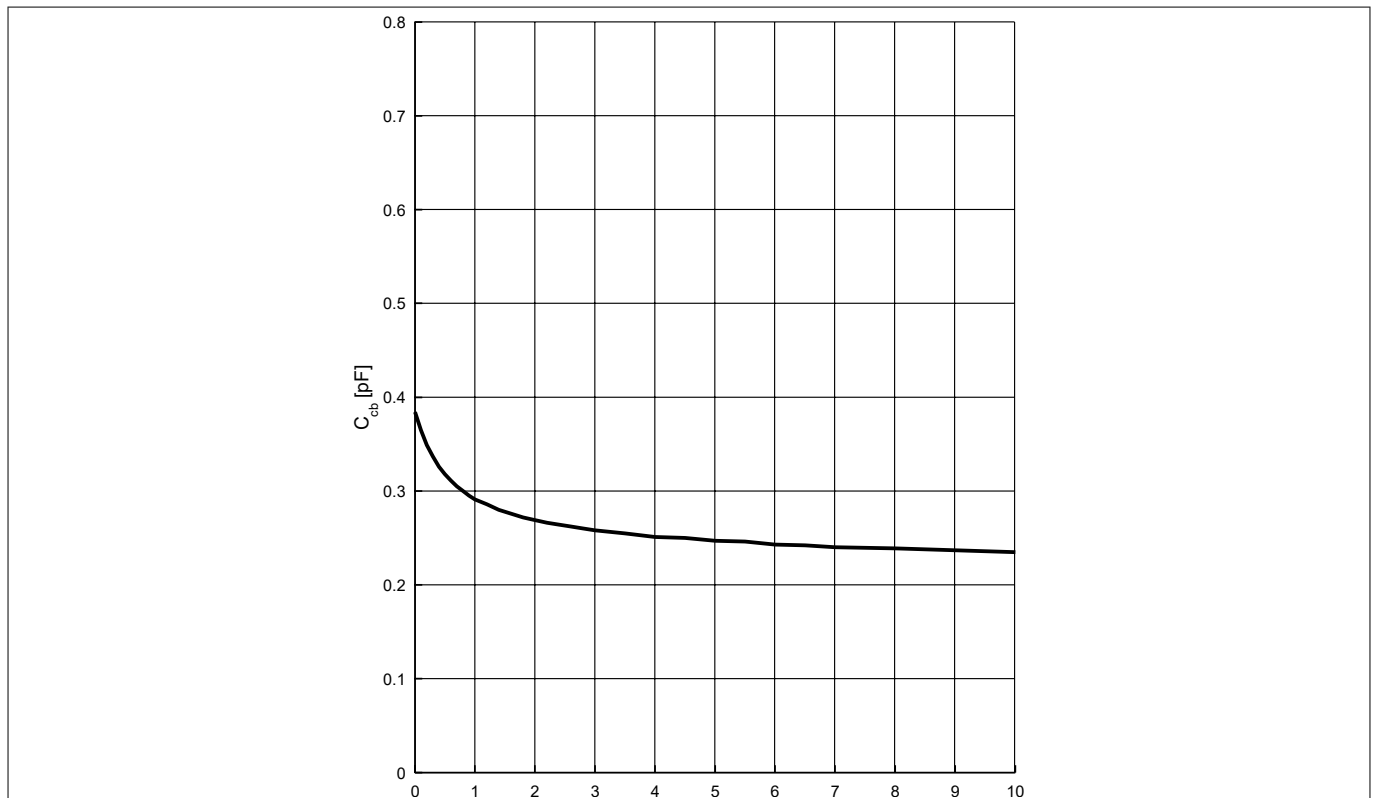


Figure 4 Collector base capacitance $C_{CB} = f(V_{CB})$, $f = 1$ MHz

Electrical characteristics

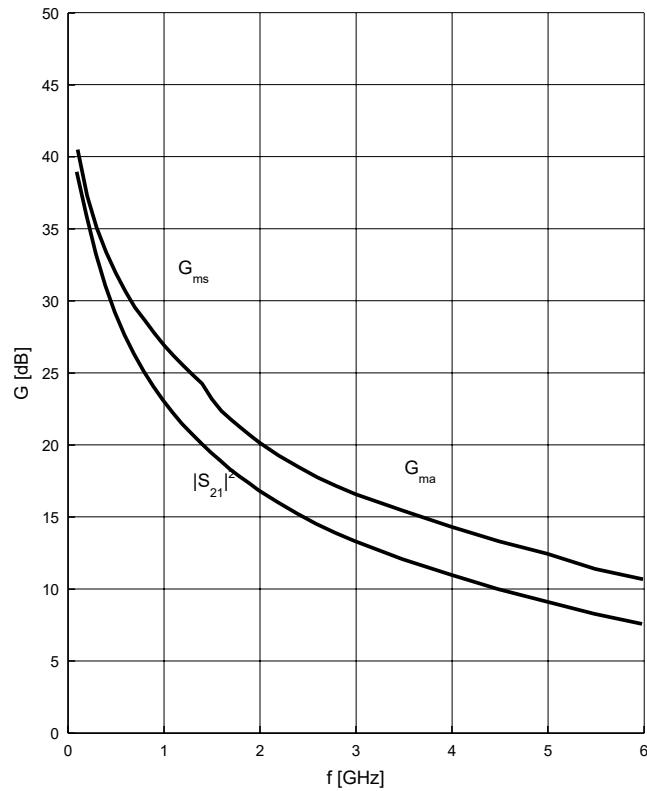


Figure 5 Gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$, $V_{CE} = 3\text{ V}$, $I_C = 80\text{ mA}$

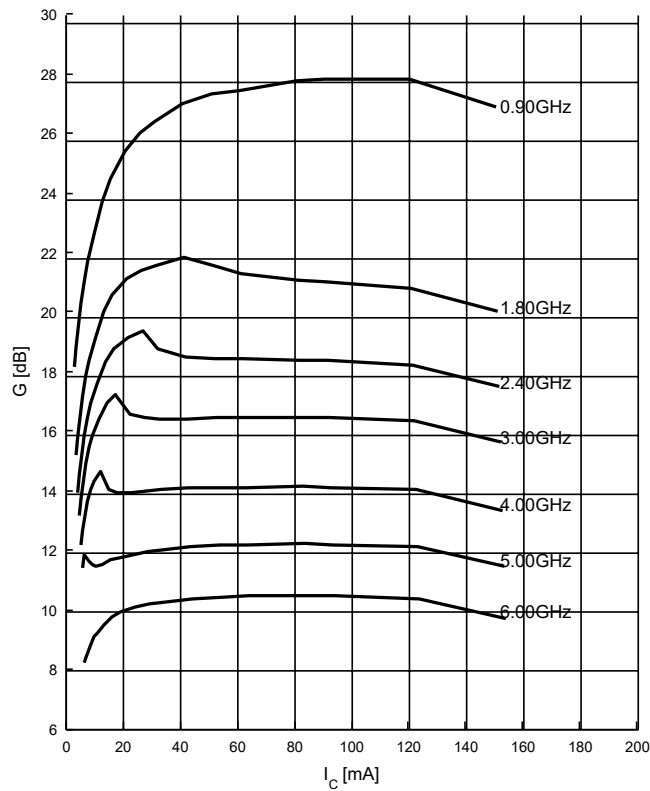


Figure 6 Maximum power gain $G_{max} = f(I_C)$, $V_{CE} = 3\text{ V}$, $f = \text{parameter in GHz}$

Electrical characteristics

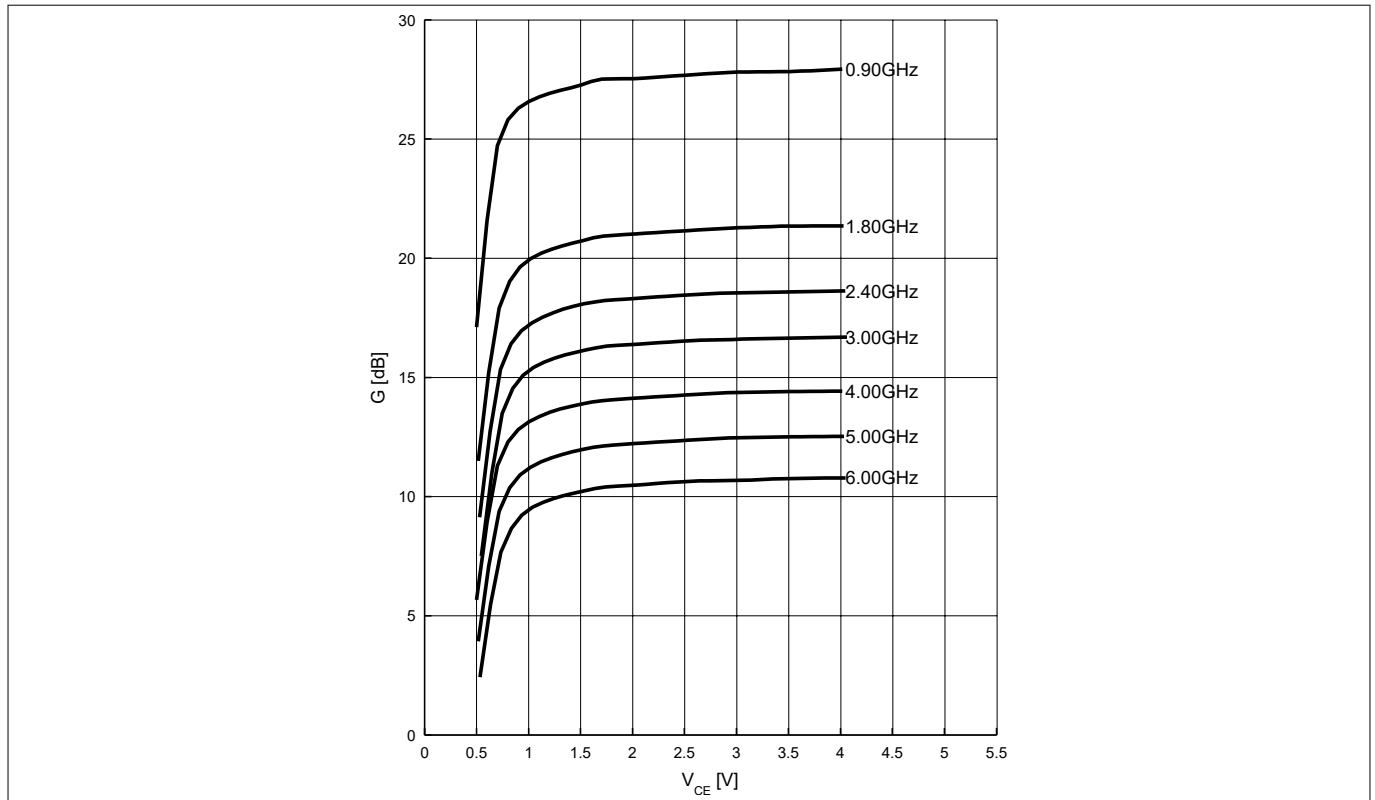


Figure 7 **Maximum power gain $G_{max} = f(V_{CE})$, $I_C = 80$ mA, f = parameter in GHz**

Note: *The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25$ °C.*

4 Package information TSFP-4-1

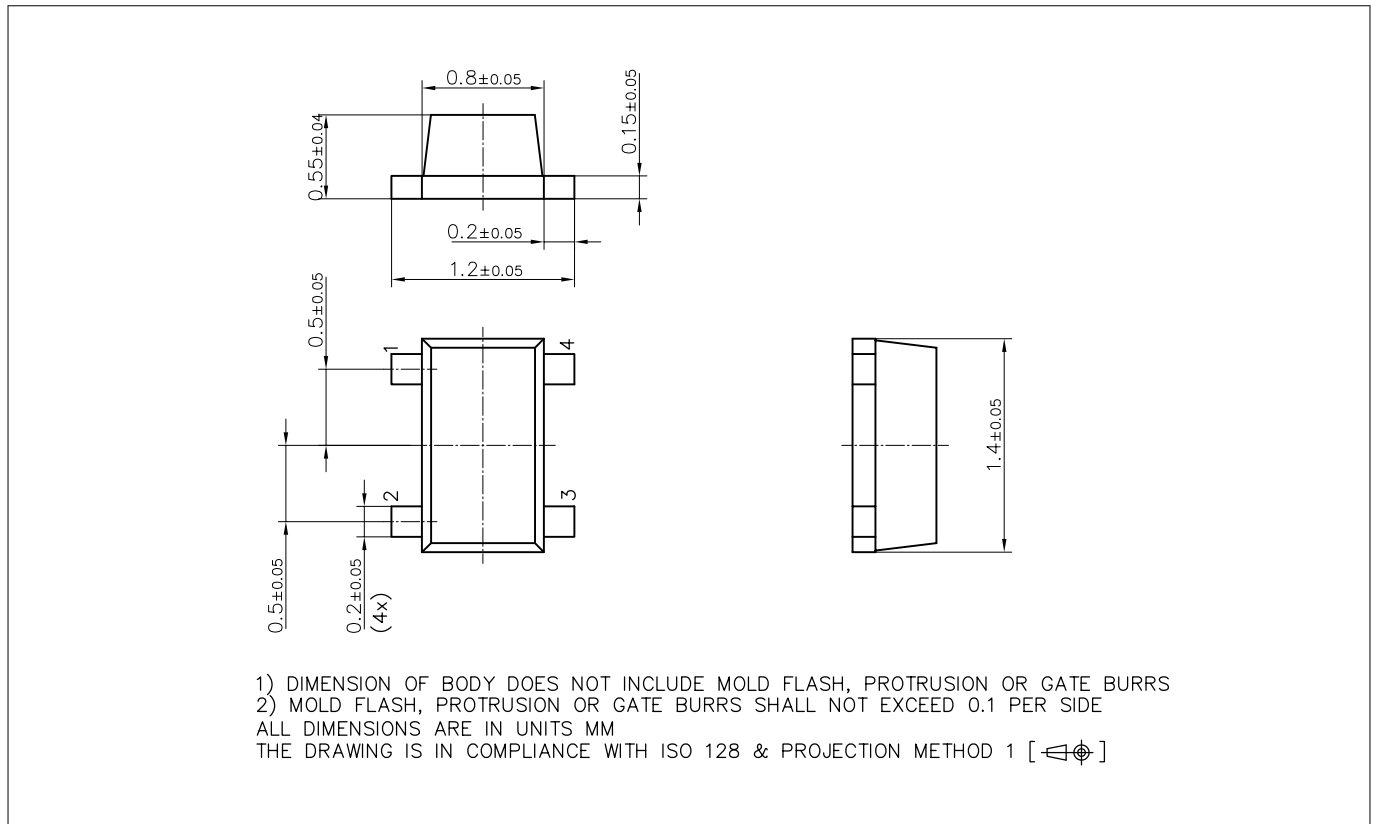


Figure 8 TSFP-4-1 package

Note: For package information including footprint, packing and assembly recommendation refer to:

<https://www.infineon.com/packages/TSFP-4-1/>

Revision history

Revision history

Document version	Date of release	Description of changes
Revision 2.0	2019-01-25	New datasheet layout.
Revision 3.0	2024-07-01	Updated product validation

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2024-07-01

Published by

Infineon Technologies AG
81726 Munich, Germany

© 2024 Infineon Technologies AG
All Rights Reserved.

Do you have a question about any aspect of this document?

Email: erratum@infineon.com

Document reference
IFX-bts1525792198227

Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenhheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.